

SR03A~SR03M

Surface Mount Standard Rectifiers

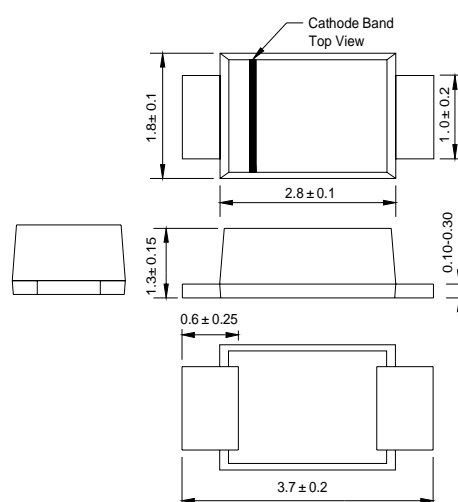
Features

- Low profile space
- Ideal for automated placement
- Glass passivated chip junctions
- Low forward voltage drop
- Low leakage current
- High forward surge capability
- High temperature soldering:
260°C/10 seconds at terminals
- Component in accordance to
RoHS 2002/95/1 and WEEE 2002/96/EC

Mechanical Date

- **Case:** JEDEC SOD-123FL molded plastic body over glass passivated chip
- **Terminals:** Solder plated, solderable per J-STD-002B and JESD22-B102D
- **Polarity:** Laser band denotes cathode end
- **Weight:** 0.017gram

SOD-123FL



Dimensions in millimeters

Maximum Ratings & Thermal Characteristics & Electrical Characteristics

($T_A = 25\text{ }^\circ\text{C}$ unless otherwise noted)

	SR-	Symbol	03A	03B	03D	03G	03J	03K	03M	UNIT
Maximum repetitive peak reverse voltage		V_{RRM}	50	100	200	400	600	800	1000	V
Maximum RMS voltage		V_{RMS}	35	70	140	280	420	560	700	V
Maximum DC blocking voltage		V_{DC}	50	100	200	400	600	800	1000	V
Maximum average forward rectified current		$I_{F(AV)}$	0.3							A
Peak forward surge current 8.3 ms single half sine-wave superimposed on rated load		I_{FSM}	15							A
Maximum instantaneous forward voltage at 0.3A		V_F	1.1							V
Maximum DC reverse current at Rated DC blocking voltage		I_R	5.0 50							μA
Thermal resistance from junction to ambient (Note1)		$R_{\theta JA}$	220							$^\circ\text{C}/\text{W}$
Operating junction and storage temperature range		T_J, T_{STG}	-55 to +150							$^\circ\text{C}$

Note1: Mounted on FR-4 P.C.B. With 0.9x1.5 mm copper pad areas ($\approx 35\text{ }\mu\text{m}$ thick)

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Characteristic Curves ($T_A=25^\circ\text{C}$ unless otherwise noted)

Fig.1 Forward Current Derating Curve

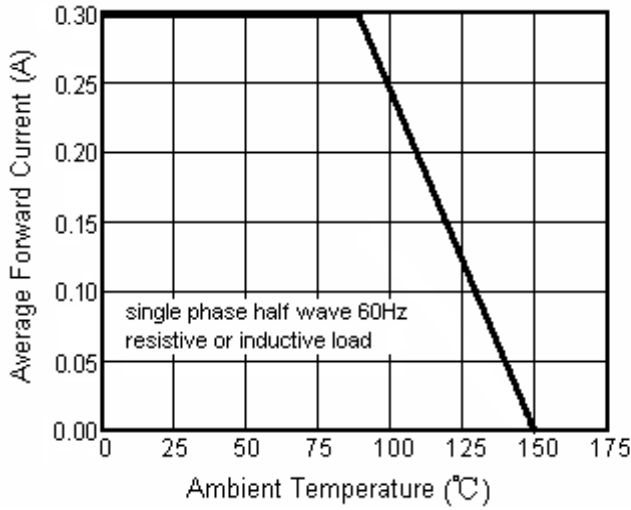


Fig.2 Maximum Non-Repetitive Peak Forward Surge Current

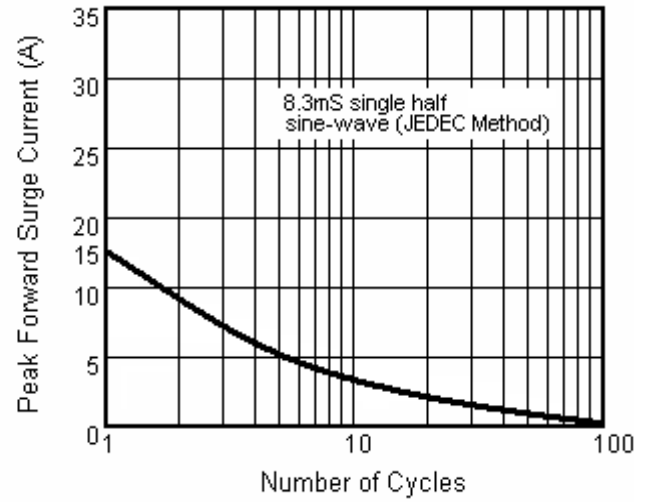


Fig.3 Typical Instantaneous Forward Characteristics

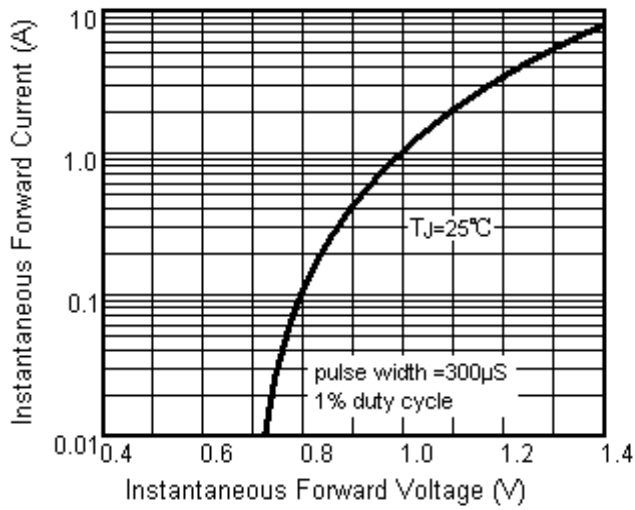


Fig.4 Typical Reverse Characteristics

